Schottky Barrier Diode

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

Features

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.28 Volts (Typ) @ $I_F = 1$ mAdc
- Low Reverse Current
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



ON Semiconductor®

http://onsemi.com

40 V SCHOTTKY BARRIER DIODE





SOD-323 CASE 477 STYLE 1

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---------------------------------|------------------|------------------------------|------|
| Peak Reverse Voltage | V _{RM} | 40 | V |
| Reverse Voltage | V _R | 30 | Vdc |
| Forward Continuous Current (DC) | IF | 30 | mA |
| Peak Forward Surge Current | I _{FSM} | 500 | mA |
| Electrostatic Discharge | E _{SD} | HBM Class: 1C MM Class: A | |

THERMAL CHARACTERISTICS

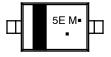
| Characteristic | Symbol | Max | Unit |
|--|-----------------------------------|----------------|-------|
| Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C | P _D | 200 | mW |
| Derate above 25°C | | 1.57 | mW/°C |
| Thermal Resistance Junction-to-Ambient | $R_{\theta JA}$ | 635 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1

1. FR-5 Minimum Pad

MARKING DIAGRAM



5E = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

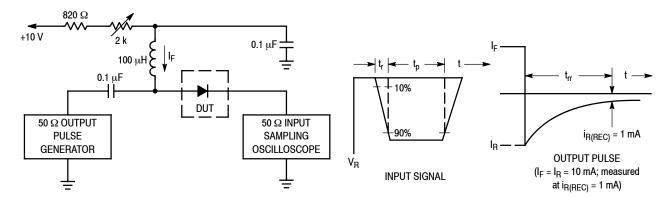
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------|----------------------|-----------------------|
| RB751V40T1G | SOD-323 (Pb-Free) | 3000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

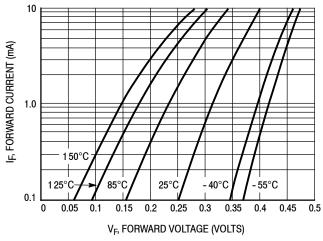
| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|--------------------|-----|------|------|-------|
| Reverse Breakdown Voltage (I _R = 10 μA) | V _{(BR)R} | 30 | - | - | Volts |
| Total Capacitance (V _R = 1.0 V, f = 1.0 MHz) | C _T | - | 2.0 | 2.5 | pF |
| Reverse Leakage (V _R = 30 V) | I _R | - | 300 | 500 | nAdc |
| Forward Voltage (I _F = 1.0 mAdc) | V _F | - | 0.28 | 0.37 | Vdc |



Notes: 1. A 2.0 $k\Omega$ variable resistor adjusted for a Forward Current (IF) of 10 mA.

- 2. Input pulse is adjusted so $I_{R(peak)}$ is equal to 10 mA.
- 3. $t_p \gg t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit



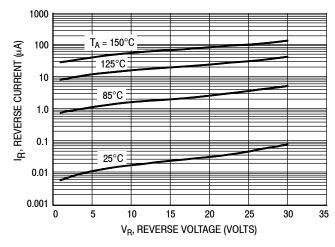


Figure 2. Typical Forward Voltage

Figure 3. Reverse Current versus Reverse Voltage

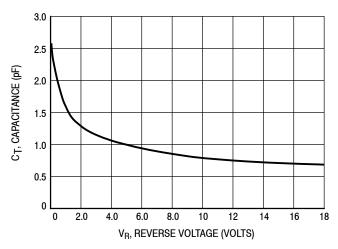
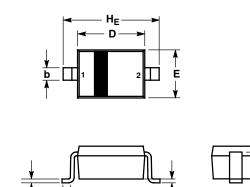


Figure 4. Typical Capacitance

PACKAGE DIMENSIONS

SOD-323 CASE 477-02 **ISSUE H**



NOTE 5

NOTE 3

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.

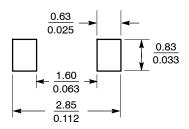
 4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

 5. DIMENSION L IS MEASURED FROM END OF RADIUS.

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|-------|-----------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.80 | 0.90 | 1.00 | 0.031 | 0.035 | 0.040 |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 |
| А3 | 0.15 REF | | | 0.006 REF | | |
| b | 0.25 | 0.32 | 0.4 | 0.010 | 0.012 | 0.016 |
| С | 0.089 | 0.12 | 0.177 | 0.003 | 0.005 | 0.007 |
| D | 1.60 | 1.70 | 1.80 | 0.062 | 0.066 | 0.070 |
| E | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 |
| L | 0.08 | | | 0.003 | | |
| HE | 2.30 | 2.50 | 2.70 | 0.090 | 0.098 | 0.105 |

STYLE 1: PIN 1. CATHODE 2. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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